

	Date: Company Name:				
	Contact Name:				
Coating Machine – Necessary Specifications					
Coating method(s):	\square MICROGRAVURE TM	□Slot Die □	∃Knife (comma)		
Coating width:	mm	Target coating t	:hickness:	μm	
Type of coating fluid:					
Type of solver	nt(s):			-	
Solid Ratio:				-	
Viscosity:					
Type of substrate:					
Substrate width:	mm	Substrate thickn	ness:	μm	
Unwinder/Rewinder:					
Substrate roll max dia	ameter: r	nm			
Substrate roll max we	eight: kg				
Cores Diameter:	□3" / □6"				
Core width:	mm				
Dryer:					
Length:	m				
Temperature:	°C				
Type:					
Line speed:	m/min				
Tension:	. N				
Tension control:	□Yes / □No				
If Yes:	□Automatic /	□Manual (ML&I	MLDX are manual o	only)	
Options: □Dry I	Laminator □Inter	leaf peeler $\qquad \Box$	UV Corona	\Box PLC	